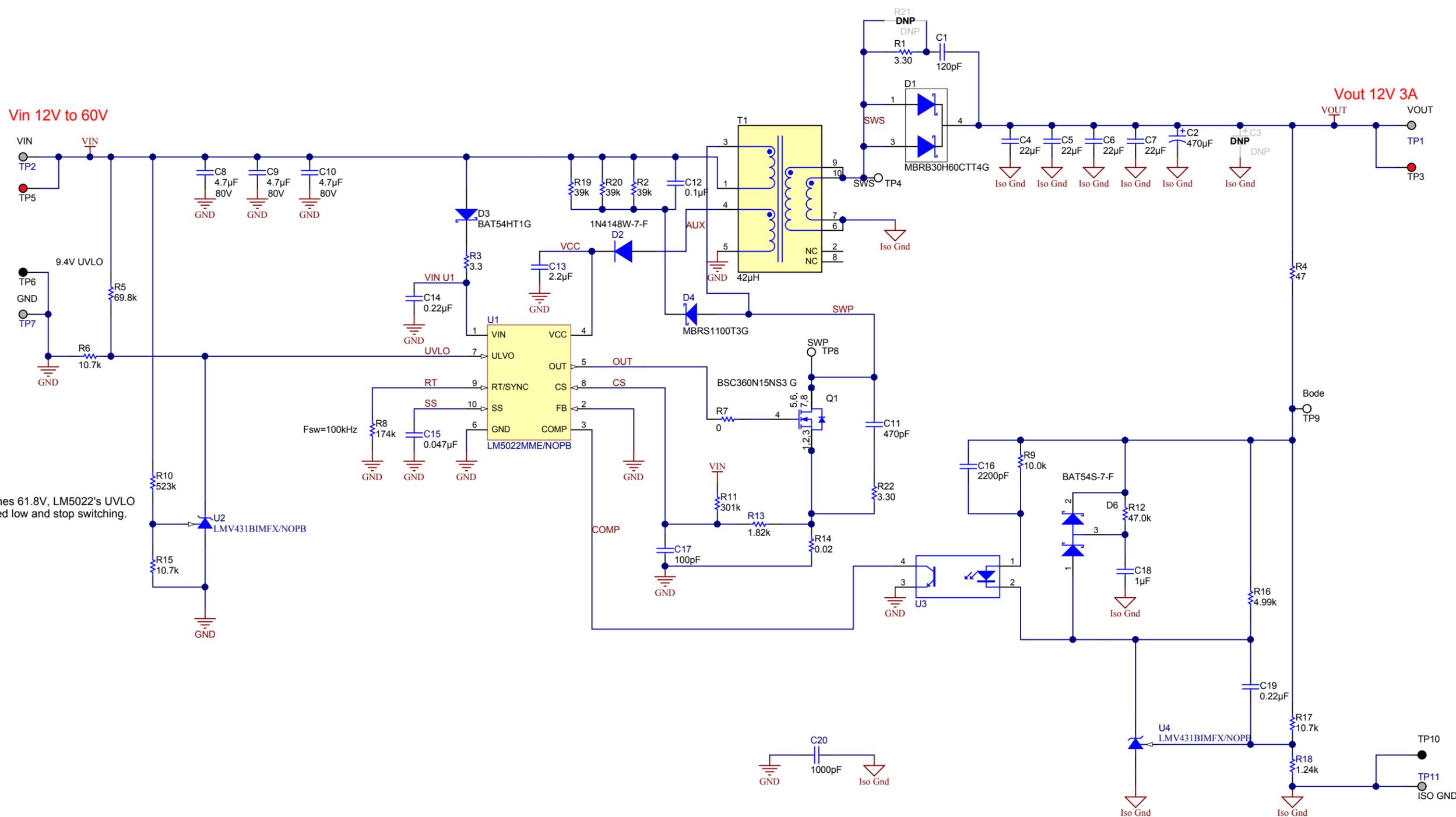


Vin 12V to 60V

Vout 12V 3A

Vin OVP:
When Vin reaches 61.8V, LM5022's UVLO pin will get pulled low and stop switching.



Orderable: N/A	Designed for: Public Release	Mod. Date: 3/7/2017
TID #: PMP20551	Project Title: LM5022 36W Wide Vin Flyback	
Number: PMP20551	Rev: A	Sheet Title:
SVN Rev: Version control disabled	Assembly Variant: 001	Sheet: 1 of 2
Drawn By:	File: PMP20551_REVA_SchDoc	Size: B
Engineer: Xinyu Dai	Contact: http://www.ti.com/support	

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PCB Number: PMP20551
PCB Rev: A

PCB
LOGO
Logo1

Label Table	
Variant	Label Text
001	

ZZ1
Assembly Note
 These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ2
Assembly Note
 These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ3
Assembly Note
 These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

Orderable: N/A	Designed for: Public Release	Mod. Date: 10/31/2016	 TEXAS INSTRUMENTS http://www.ti.com © Texas Instruments 2016
TID #: PMP20551	Project Title: LM5022 36W Wide Vin Flyback		
Number: PMP20551	Rev: A	Sheet Title:	
SVN Rev: Version control disabled	Assembly Variant: 001	Sheet: 2 of 2	
Drawn By: Xinyu Dai	File: PMP20551_REVA_Hardware.SchDoc	Size: B	
Engineer: Xinyu Dai	Contact: http://www.ti.com/support		

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